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09/687,048INFORMATION DISCLOSURE
STATEMENT BY APPLICANTAPPLICANT
Tae Heon Lee et al.

(37 CFR 1.8(b))

(Use several sheets if necessary)

FILING DATE
10/13/2000GROUP
2814

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	PATENT NUMBER	ISSUE DATE	PATENTEE	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION						
	DOCUMENT NUMBER	PUBLICAT ION DATE	COUNTRY OR PATENT OFFICE	CLASS	SUBCLASS	TRANSLATION YES NO
DLN	10 2 5 6 2 4 0	09/25/98	Japan			
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EXAMINER

Richard Ruyne

DATE CONSIDERED

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EXAMINER: Initial citation considered. Draw line through citation if not in conformation and not considered. Include copy of this form with next communication to applicant.

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PATENTSIVABUT02A.881



Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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Remarks






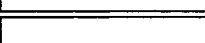
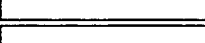
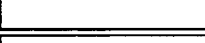







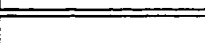
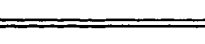
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Examiner Name	Date
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<i>Delia's Nguyen</i>	6/16/03

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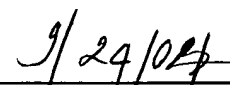
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Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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<i>Delia S. Guyer</i>	<i>9/24/04</i>

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